

Status of the B-TOF at Panda

Sebastian Zimmermann
On behalf of the Panda SciTil group

Stefan-Meyer-Intitut, 09.09.2017

Outline

- Current status
- New Railboard v3
- Current Supermodule
- New Supermodule Design
- Material Budget
- Advantages / Disadvantages
- Open Projects

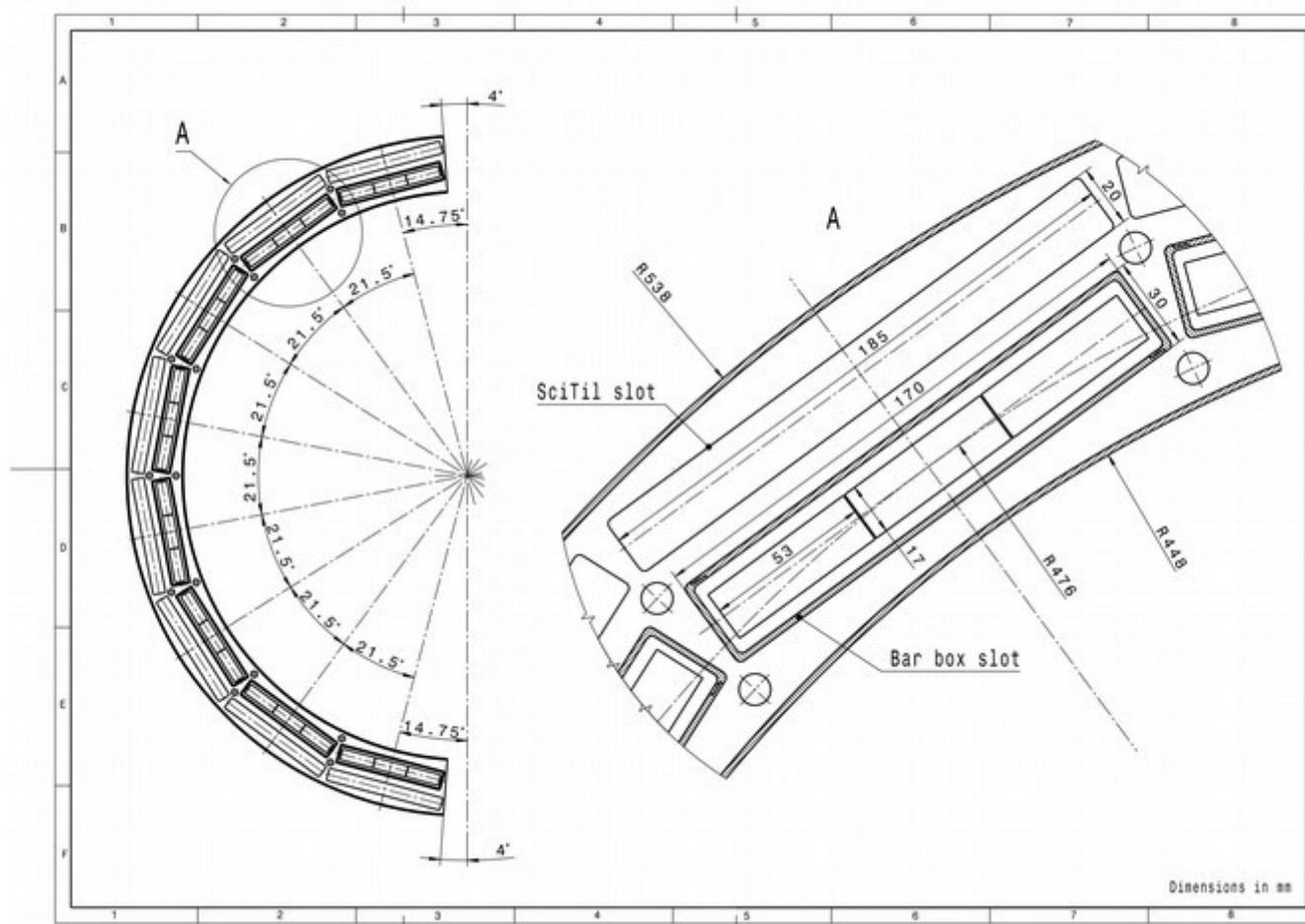
Current Status

- Scintillator performance tested
 - Electron source → 50 ps time resolution
- The **TDR** was approved (2018)
- **2 versions** of the backbone PCB (the **Railboard**) have been tested
 - Potential publication
- A **new board** will be ordered shortly
 - This includes a **redesign** of the B-TOF holding structure
- 2018 **parasitic beamtime** is currently **being analyzed**

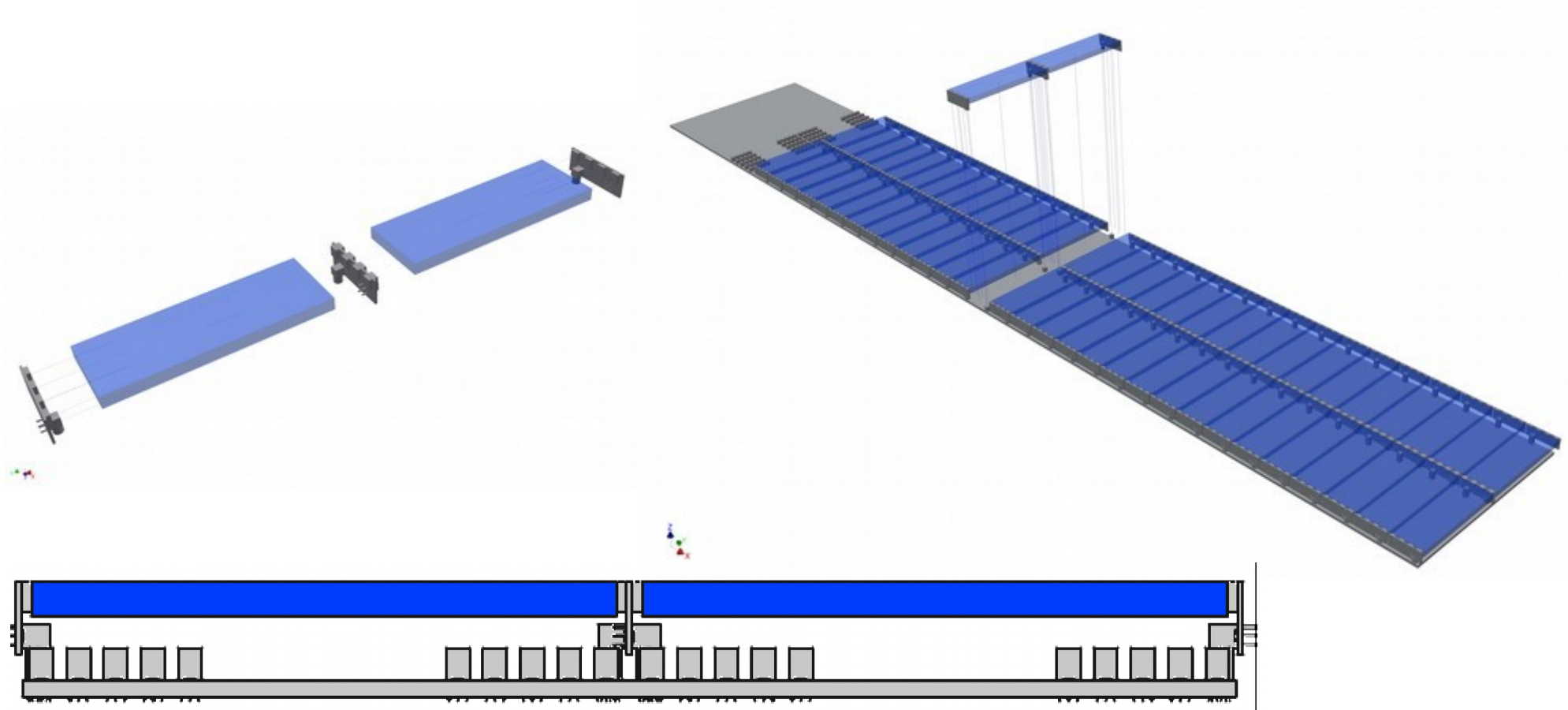
The New Railboard

- We found companies which theoretically **could produce > 1800 mm boards**
 - Thales PCB
 - CERN Micro-Pattern Technologies
- With certain material **limitations** however
- **Low loss** PCB material (eg. Rogers 4000 series) has a limited size
 - Boards have to be **split into 2** or 3 parts due to material availability
- Current plan:
 - Use low loss material Rogers 4003C
 - **Split** the sensitive part of the detector into two parts and four boards
 - Combine them using **connecting cables**
 - Splitting the **FEE side** of the PCB is **no issue**, since the ASICs need to interface somehow anyway
 - Low loss material has less rigidity than FR4
 - Additional holding structures necessary

Limitations / Requirements

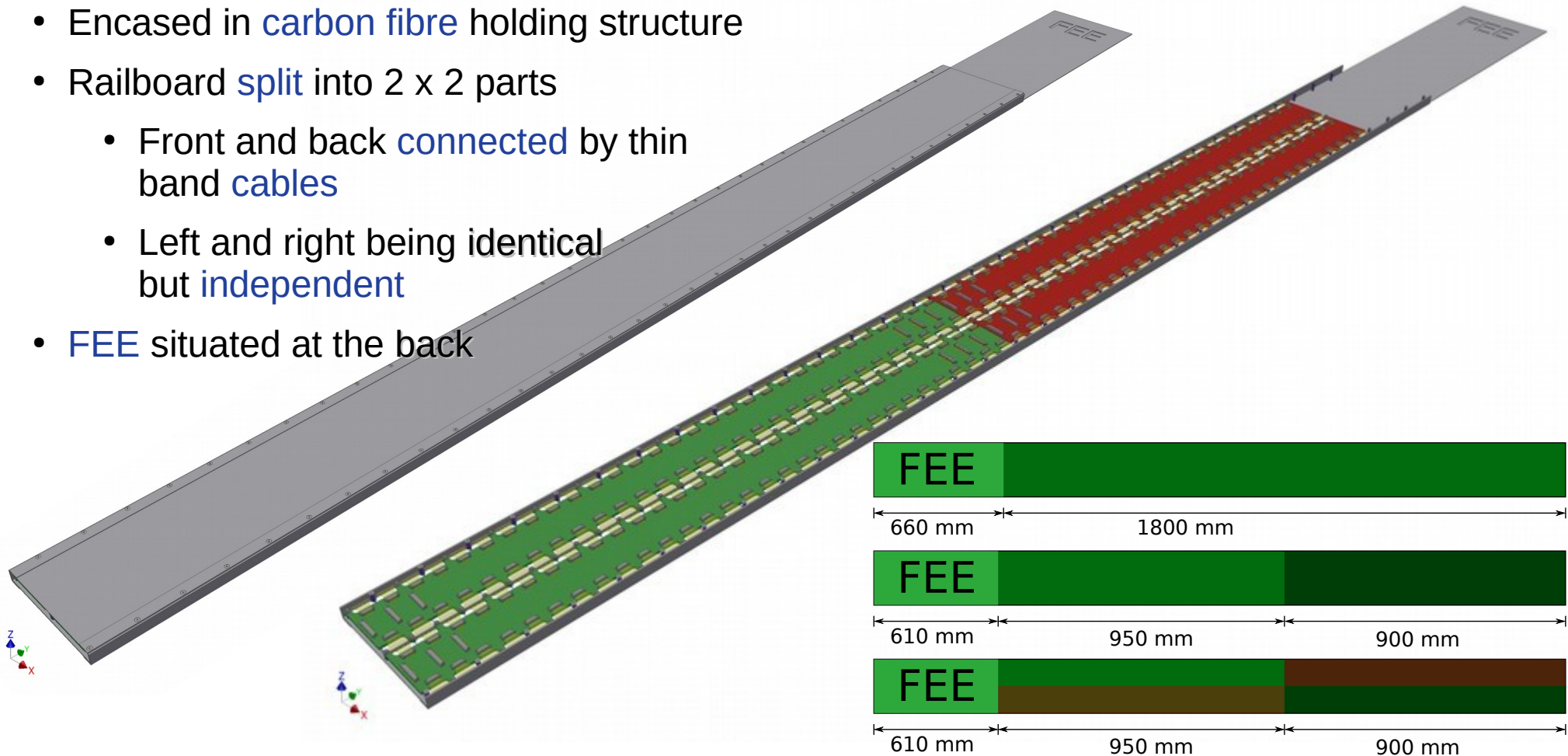


Old Supermodule

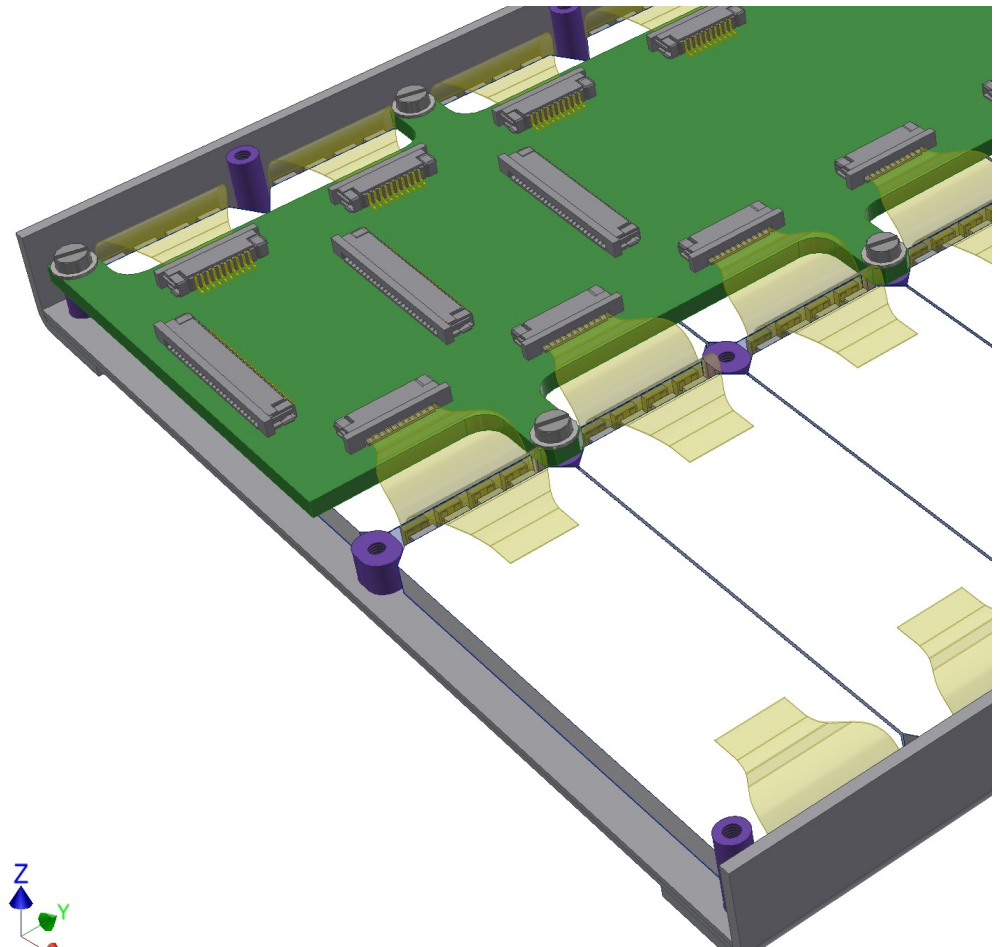
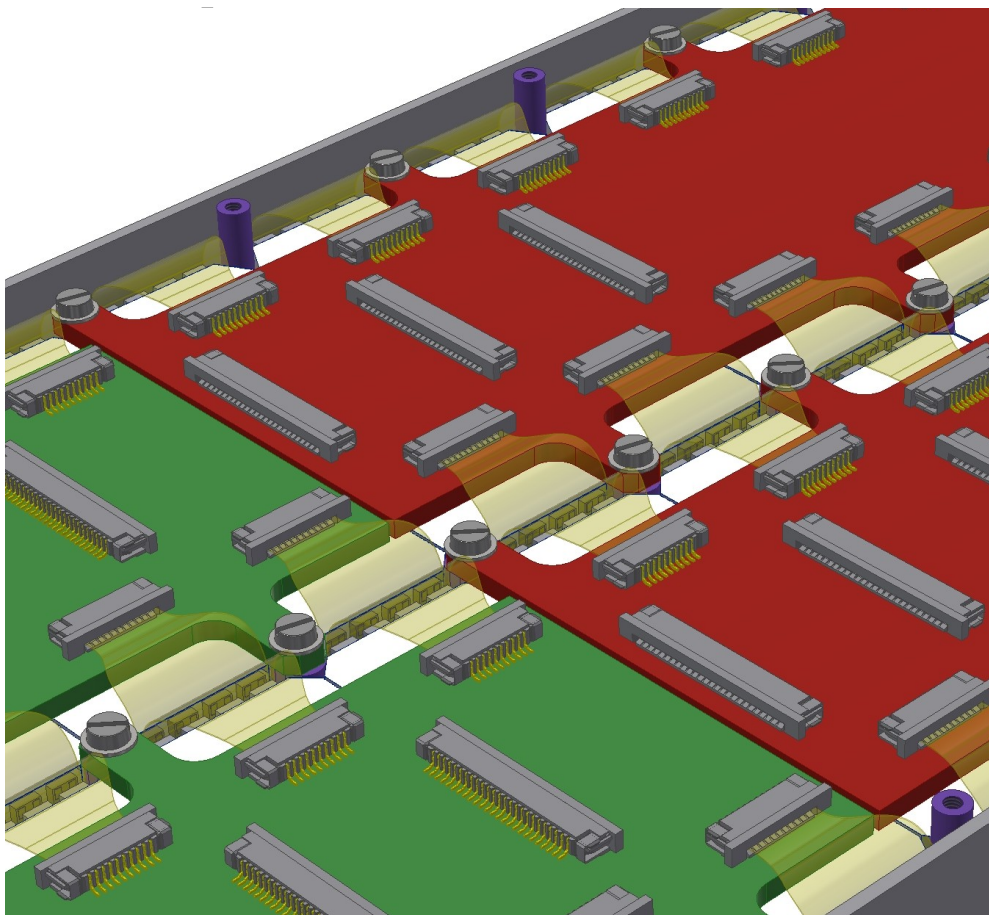


New Supermodule Design

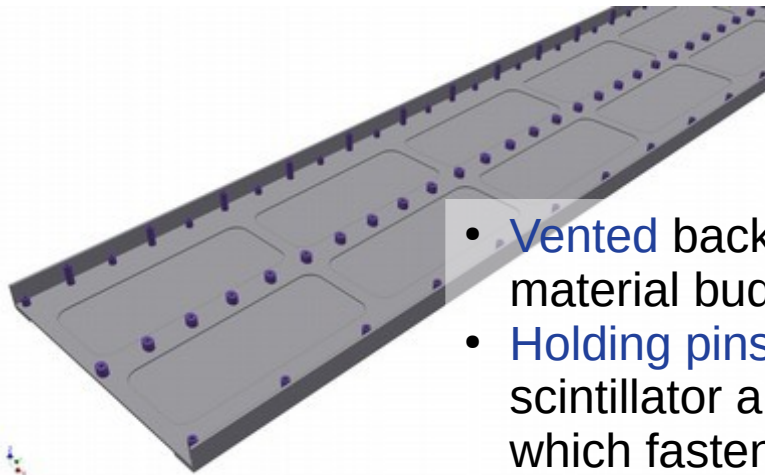
- Encased in **carbon fibre** holding structure
- Railboard **split** into 2 x 2 parts
 - Front and back **connected** by thin band **cables**
 - Left and right being identical but **independent**
- **FEE** situated at the back



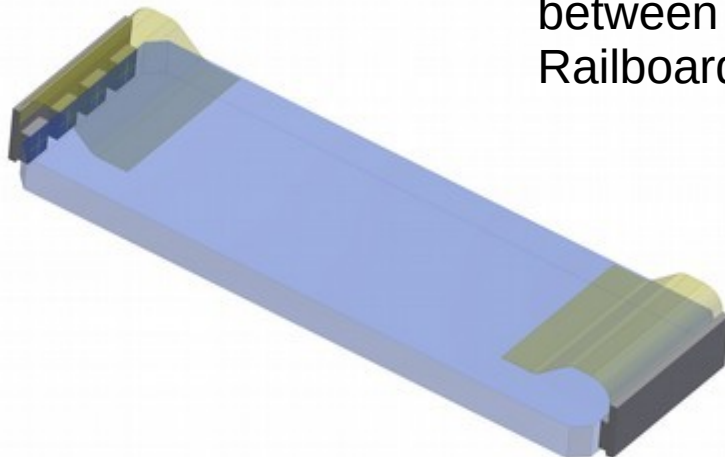
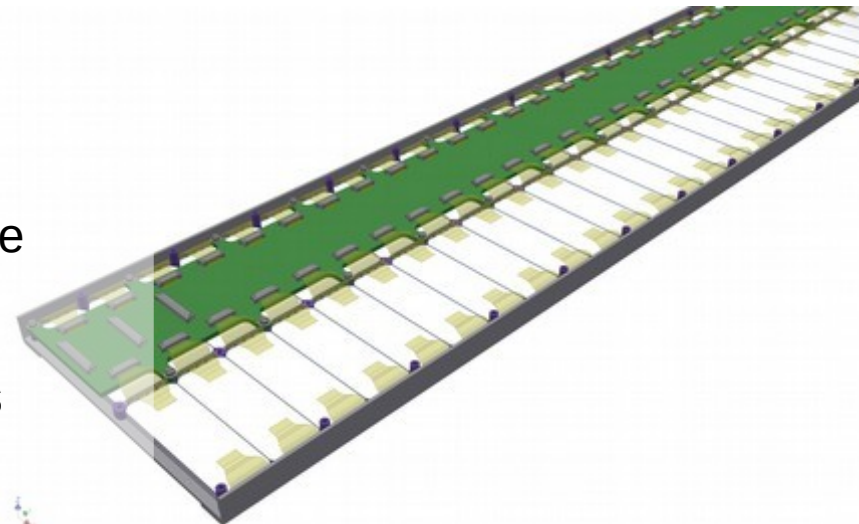
Scintillator holding & Railboard connection



Back plane & Scintillators



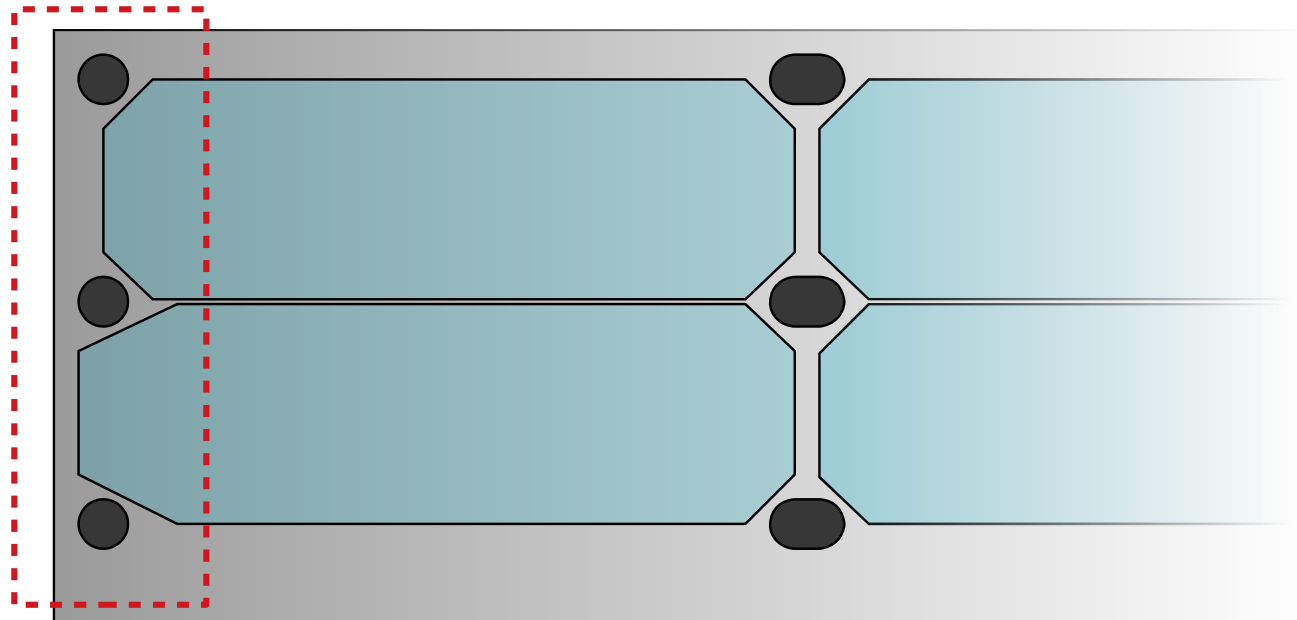
- **Vented** back plate to reduce material budget
- **Holding pins** to constrict scintillator and hold screws which fasten the Railboard
- **Scintillator** sandwiched in between the carbon fibre and the Railboard



- **tapered** edges to fit holding slots
- **Glued** SiPMs on scintillator
- Flex cable to Railboard

Scintillator Taper

- Two ways to **taper** the scintillators
 - **Symmetric** on both sides
 - Increase angle on one side to achieve a **larger scintillator coverage**



Material Budget

- 3 x 1 mm carbon fibre layers
- Material Budget:

- 5 mm Scintillator

- Considered as homogeneous plate, replacing plastic screws and bumper

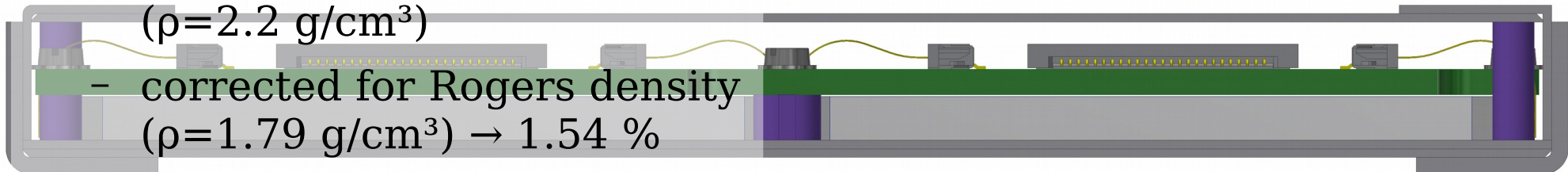
Material	Carbon fibre	Rogers	Copper	Scintillator	SiPMs
X/X_0	1.21 %	1.54 %	1.07 %	1.2 %	0.1 %

- Total = 5.09 %

- 3 mm PCB (hydro-carbon ceramic/Rogersmaterial RO4003C)

- Estimation done with PTFE ($\rho=2.2 \text{ g/cm}^3$)

- corrected for Rogers density ($\rho=1.79 \text{ g/cm}^3$) $\rightarrow 1.54 \%$



Advantages / Disadvantages

- Sensitivity to single part **tolerances** is reduced
 - Scintillators are **held firmly** in place from all angles without putting **pressure** on the wrapping
 - SiPM-Scintillator joint does **not carry any weight**
 - Leads to a longer lifetime of that connection
 - All parts **modular** and easily swappable
- **Material budget** is higher than anticipated ($X/X_0 \sim 5 \%$)
 - **More parts** for assembly
 - Specialized carbon fibre production is **expensive**

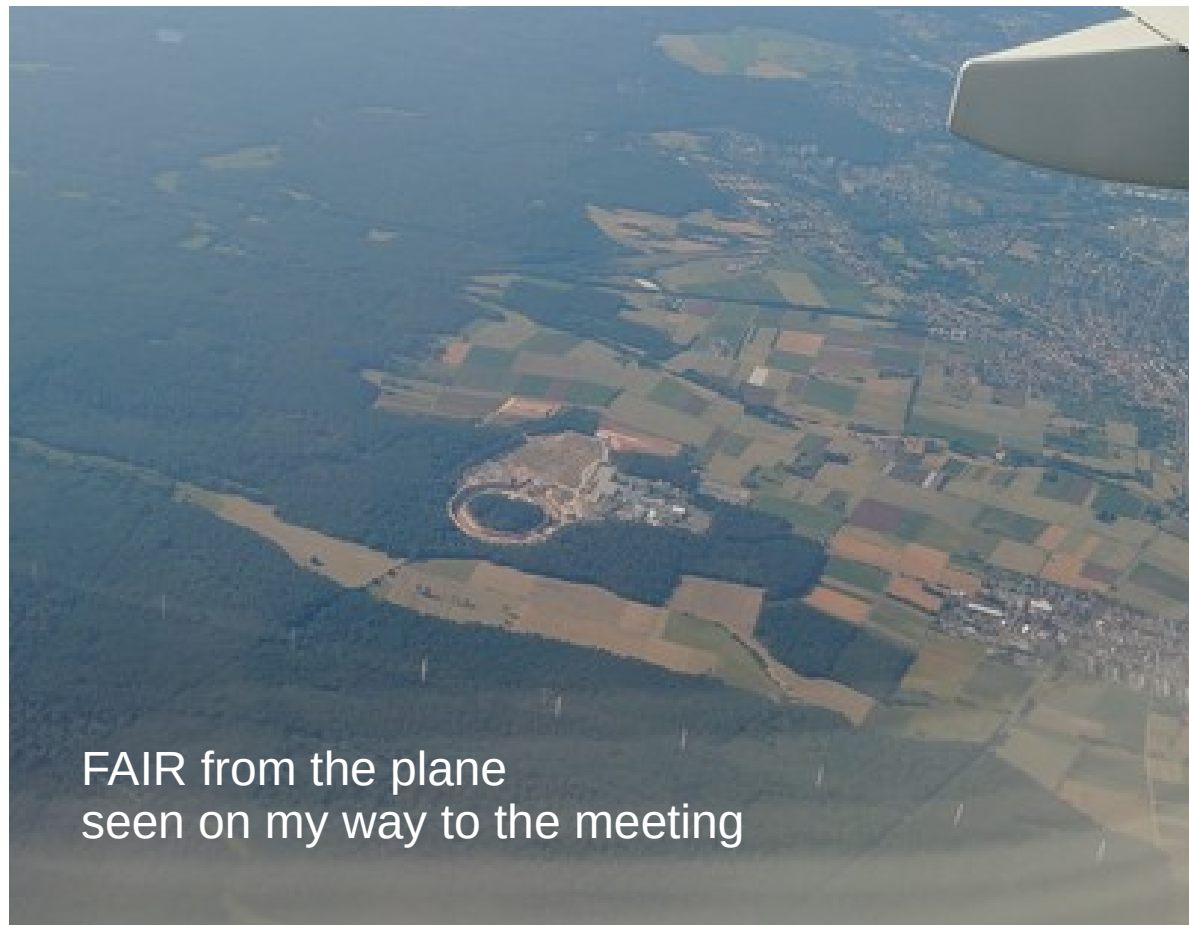
Supermodule Design Comparison

- Old design:
 - Scintillators held by glue to the SiPMs
 - SiPMs soldered to sensor board
 - Sensor board connects to railboard and held by MMCX connectors
 - Railboard acts as backbone
- New Design:
 - Scintillator still glued to SiPMs but held by support structure
 - SiPMs soldered to sensor board
 - Sensor board connects via flex PCB to Railboard, held by screws
 - Railboards are reduced and additional support structure (carbon) added, sandwiching the scintillators

Open Projects

- Integration of **temperature sensors**
- **LED** calibration System
- **Readout electronics:**
 - Get commercial version up and running
 - redesign / restructure commercial boards
 - Disc DIRC Group in Gießen is working with the same boards and have similar requirements
- Evaluation of updated **Railboard**
- Full **assembly** of (partial) system

Thank you for your attention



FAIR from the plane
seen on my way to the meeting